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## Structure and tribological properties of TiN coatings grown by hybrid HIPIMS and CFUBMS deposition

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**Abstract:** Over the past decade, high power impulse magnetron sputtering (HIPIMS) has attracted substantial attention because of its ultra-dense plasma deposition environment. However, early examples of the HIPIMS process showed significantly decreased deposition rates. In this paper, a hybrid process utilising one HIPIMS powered magnetron in a closed field unbalanced magnetron sputtering (CFUBMS) configuration with other three direct current (DC) powered magnetrons, was developed to grow a TiN hard coating reactively on high speed steel and stainless steel substrates, to compare with a similar TiN coating grown purely by reactive CFUBMS deposition. The deposited coatings were characterized by XRD, FEG-SEM and cross-sectional TEM, and evaluated by Knoop indentation and un-lubricated ball-on-disk tribo-tests. The results showed that the hybrid sputtering process achieved a deposition rate of 0.047  $\mu\text{m}/\text{min}$ , only about 23% lower than the pure DC sputtering. The benefits of including HIPIMS in hybrid sputtering deposition have been found to be the increase in the hardness of the coating from 3.5 to 3.9 GPa and, perhaps more importantly, a significant reduction in the magnitude of the compressive residual stress in the coating, from -6.0 to -3.5 GPa. The dry sliding coefficient of friction and the specific wear coefficients were in the range of 0.8-0.9 and 1 to  $2 \times 10^{-15} \text{ m}^3\text{N}^{-1}\text{m}^{-1}$  respectively.

**Key Words:** Magnetron sputtered coatings; HIPIMS; TiN; TEM; Friction and wear

HIGH POWER IMPULSE MAGNETRON SPUTTERING (HIPIMS), also known as HPPMS (high power pulsed magnetron sputtering), was firstly reported in late 1990's<sup>[1]</sup> and soon attracted the attention of researchers because of the significantly high ionization ratios which could be achieved with HIPIMS, as compared to conventional magnetron sputtering processes. Up to now, HIPIMS technology has been widely recognized both in the deposition of dense coatings and in the enhancement of interface adhesion by metal ion etching prior to coating deposition<sup>[2-3]</sup>. In particular, hard coatings grown by HIPIMS were reported to have dense structure and smooth surface<sup>[2-4]</sup>. However, the early HIPIMS technology was associated with substantially lower deposition rates when compared to other magnetron sputtering techniques<sup>[5-7]</sup>. To improve the deposition rate, recent efforts have been mainly focused on either adjusting the HIPIMS power input to moderate levels<sup>[8-9]</sup> or in developing hybrid deposition processes<sup>[10-12]</sup>. In the latter approach, HIPIMS is introduced to a multi-target deposition system to combine with other deposition technologies having higher deposition rates. One example of a successful hybrid deposition technique is the authors' recent work on the deposition of TiMoN multilayer coatings using the hybrid HIPIMS and close field unbalanced magnetron sputtering (CFUBMS) deposition<sup>[12]</sup>.

In this paper, we report a comparative study of TiN coatings grown by the hybrid HIPIMS / DC CFUBMS process and the pure DC CFUBMS

process. Cross-sectional transmission electron microscopy (XTEM), X-ray diffraction (XRD) and field emission gun scanning electron microscopy (FEG-SEM) were employed in the coating characterization, while the mechanical and tribological properties of the coatings were evaluated by Knoop indentation and un-lubricated ball-on-disk tribo-tests respectively. The objective of the research was to achieve a comprehensive understanding of the effect of the incorporated HIPIMS power supply on the structure and properties of the deposited coating, which would contribute to a deeper understanding of the coating growth kinetics.

### 1. Experimental

#### 1.1 Deposition

Flat samples of hardened (64 HRC) M42 tool steel and AISI 316L stainless steel were coated using a CFUBMS coating system. Figure 1 shows a schematic diagram of the 4-magnetron system, in which pure titanium targets were used in combination with a partial pressure of gaseous nitrogen to grow the TiN hard coatings reactively. One type of TiN was deposited using standard DC power supplies on all the four magnetrons (referred to here as "4DC"). The second type was produced by using the same magnetron configuration but one of the magnetrons was supplied by a HIPIMS power unit whilst the other three magnetrons were supplied by the existing DC power supplies (referred to here as "3DC+1HIPIMS").

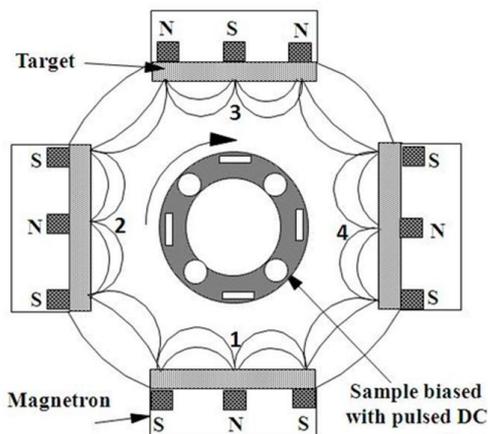


Fig. 1 Schematic diagram of the four Ti targets closed field unbalanced magnetron sputtering ion plating system: one target is connected to a HIPIMS power supply and the other three operated in a conventional DC-Magnetron mode.

The deposition procedures started with ion etching on the samples using pulsed DC power applied to the substrates on their turntable with parameters of: frequency 350.0 kHz, pulse width 0.5  $\mu$ s, and a high negative potential of -400 V. For the case of 4DC magnetrons, all magnetrons were powered at a low level of 0.1 kW and the resulting magnetron plasmas combined with the pulsed DC bias on the substrate to generate an argon plasma in the coating chamber in which the ion etching was dominated by argon ions ( $\text{Ar}^+$ ) without net deposition of Ti. For the case of the 3DC+1HIPIMS magnetrons, the magnetron with a Ti target supplied by HIPIMS was powered at 3.0 kW whilst the other 3 DC magnetrons remained at the low 0.1 kW power level so that both  $\text{Ar}^+$  and a high ratio of metallic ions ( $\text{Ti}^+/\text{Ti}$  neutral) could be produced because the HIPIMS supply was operating at a relatively high power level during this ion etching stage, as described by Kouznetsov<sup>[1]</sup>. Following the ion cleaning, the second stage was to deposit a metallic titanium adhesion layer using all the magnetrons at a high power of 3.0kW for both the 4DC and the 3DC+1HIPIMS experiments. Meanwhile, the negative bias potential of the substrate was reduced to -70V to start the net deposition of Ti coating. Reactive nitrogen gas was then introduced in the third stage of the coating process to produce first a graded interlayer and then to deposit monolithic constant stoichiometric TiN hard coatings in both the cases of 4DC and 3DC+1HIPIMS, until the deposition process was terminated. The deposition times for the 4DC and 3DC+1HIPIMS were 40 and 55 minutes respectively, to deposit TiN coatings with similar thickness.

## 1.2 Characterization

The TiN coatings deposited on the stainless steel substrate were characterized using SEM, XRD and XTEM. A FEI Nova200 FEG-SEM was employed to observe the coating surface morphology and to measure the cross-sectional thickness, being operated at 15 kV and spot 3. A computer programmed Philips X'Pert X-ray diffraction instrument was used to characterize the crystallographic properties and to determine the residual stress, using the X-ray  $\text{Cu-K}\alpha_1$  ( $\lambda = 0.154056$  nm) with the copper anode being powered at 40 kV and 40 mA. In the crystallographic characterization, the instrument was run at the Bragg-Brentano ( $\theta$ - $2\theta$ ) configuration at a step size  $0.03^\circ$  and step scanning time 300 seconds for the period of  $2\theta = 30$ -120 degree. In the measurement of residual stress, the  $\sin^2\psi$  technique was employed based on slow scans of the (111) and (220) planes at step size and time of  $0.033^\circ$  and 300-700 seconds respectively. The diffraction peak positions were determined using the parabolic model following our recent work on the optimization of XRD residual stress measurement<sup>[13]</sup>. The Young's modulus and Poisson's ratio values were taken from literature<sup>[13]</sup> to be 300 GPa and 0.23 respectively. A Philips CM20 TEM was used to characterize the cross-sectional structure of the deposited coatings. The instrument has a W-filament and was operated at 200 kV. The cross-sectional samples were prepared by the low angle ion milling method on a Gatan 691 precision ion polishing system using argon gaseous ion source. More details of the sample preparation techniques can be found in the authors' previous publication<sup>[14]</sup>.

## 1.3 Mechanical and tribological evaluations

The mechanical and tribological evaluations were carried out on the TiN coatings deposited on the hardened M42 tool steel substrate. A Mitituyo HV/HK micro-hardness tester was employed to measure the Knoop hardness at an indentation load of 25 g. A Rockwell hardness tester and a Teer ST3100 scratch tester were employed to evaluate the adhesion characteristics of the coatings. For the Rockwell indentation, an applied load of 150 kg was used. The scratch adhesion test was conducted using a 200  $\mu$ m radius conical Rockwell diamond at a normal load increasing linearly with the scratching distance, up to a maximum of 60 N, when the test was terminated to avoid damage to the diamond. Subsequently the resulting indentations and scratches were examined using an optical microscope to evaluate the adhesive delamination behaviour, qualitatively and quantitatively.

The friction and wear properties were tested using a Teer POD-1 pin-on-disc tribometer. The testing

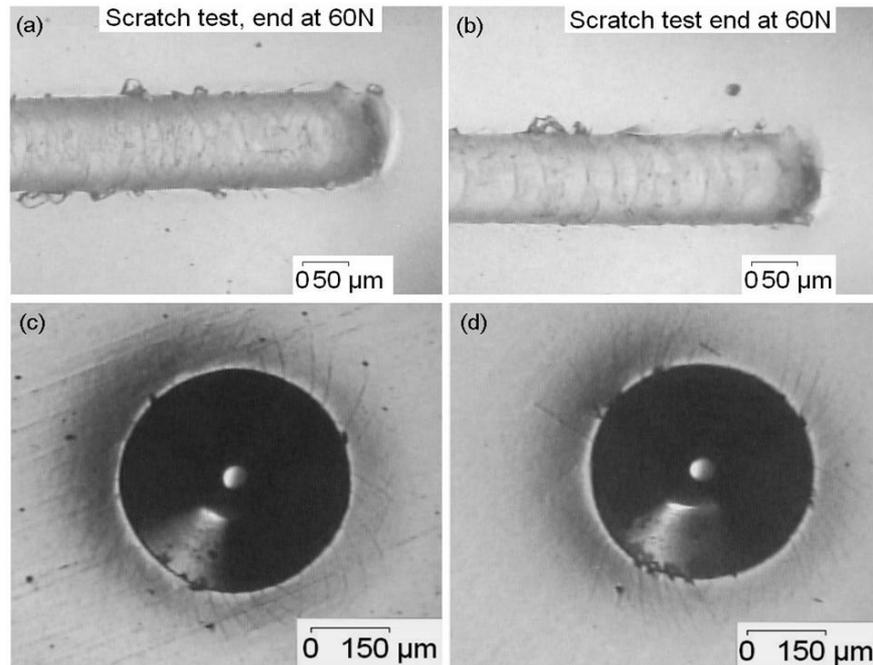


Fig. 2 Optical micrographs showing the adhesion of the TiN coatings.

conditions included a 5.0 mm diameter WC-8% Co ball as the sliding counterpart, applied normal load of 5 N, a constant linear sliding speed of 100 mm/s for three sliding wear tracks on the coated disk having nominal diameters of 6 and 10 mm, respectively, under room temperature conditions and with a relative humidity in the range RH 30-40%. For each tribotest the sliding time was 70 minutes. The resulting wear tracks were sectioned and measured using a ball-crater taper section technique to quantify the wear depth and hence to allow the calculation of wear volume loss.

## 2. Results

### 2.1 Mechanical properties

The TiN coatings grown by the 4DC and by the 3DC+1HIPIMS processes showed Knoop hardness of  $34.8 \pm 3.8$  and  $38.0 \pm 5.2$  GPa respectively. The inclusion of HIPIMS power increased the coating hardness by 3.2 GPa. In both the Rockwell indentation and the scratch tests, the applied loads only resulted in cracking in the TiN coatings due to plastic deformation of the substrate. Importantly, both coatings exhibited no adhesive failure up to the maximum scratch load of 60 N, showing excellent adhesion to the substrate. The resulting indents and scratches are shown in Figure 2. The good adhesion of the coatings was attributed to the interface enhancement achieved by the pulsed DC argon and/or Ti ion etching prior to the base layer

deposition<sup>[12]</sup>. Microscopic observations of the interface regions are shown later.

### 2.2 Structure characterization

Figure 3 shows SEM micrographs of the TiN coatings. In Figures 3a and 3b, both coatings exhibit similar surface morphology of nano scale waviness. The wave-like patterns correspond to the rough fronts of columnar growth as a result of relatively moderate ion bombardment conditions. Such phenomena have been reported in the authors' previous XTEM observations of a UBM sputtered nitride multilayer coating, TiAlN/VN, grown under a low substrate bias voltage of -75V<sup>[14]</sup> as well as in other coatings grown under similar conditions of low atomic mobility<sup>[15-17]</sup>. Figures 3c and 3d were taken from the ion-milled XTEM samples to show the cross-sectional structure of the coatings. Both coatings were void-free and dense. The metallic Ti base layer in both cases was approximately 230 nm in thickness. The corresponding thickness of the TiN top-coats was measured as 2.56 and 2.69 μm for the 4DC and 3DC +1HIPIMS coatings respectively. In the former case, the deposition rate of the DC magnetrons can be determined to be 0.064 μm/min, or 0.016 μm/min per magnetron (each powered at 3kW). From our experience in similar deposition experiments, the deposition rate from purely HIPIMS sources is approximately 25% of the rate of DC magnetron sputtering for a similar applied power. Applying this assumption to the current case, the deposition rate of

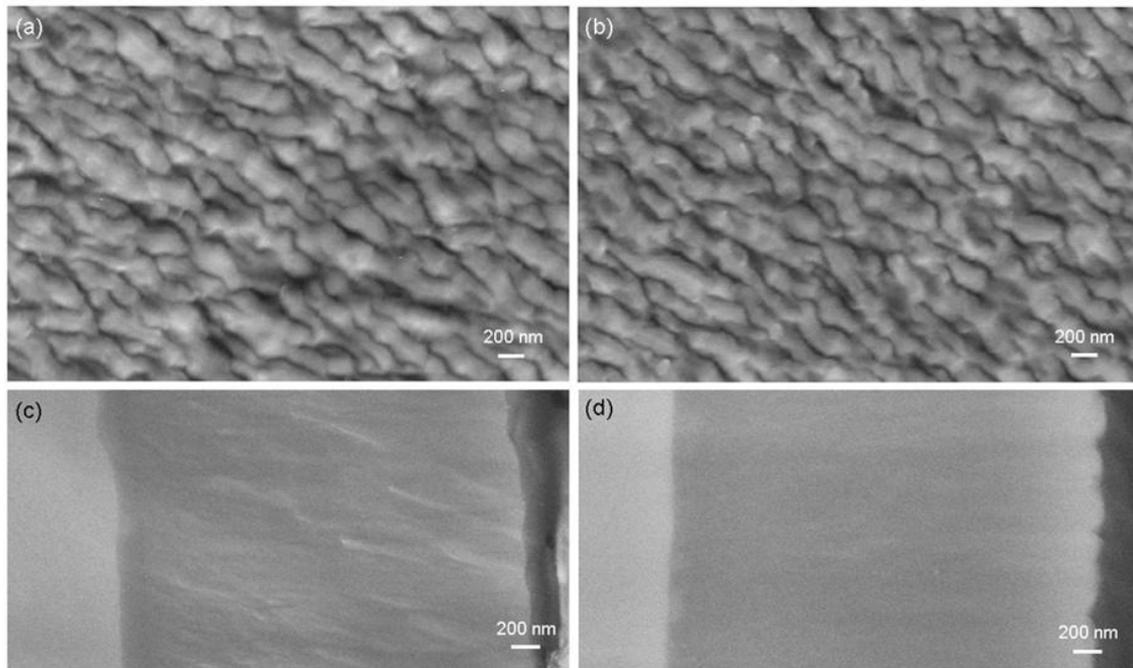


Fig. 3 SEM images of the TiN coatings: (a, c) surface and ion-beam polished cross section of the TiN coating grown by 4DC magnetrons; (b, d) surface and ion-beam polished cross section of the TiN grown by 3DC + 1HIPIMS.

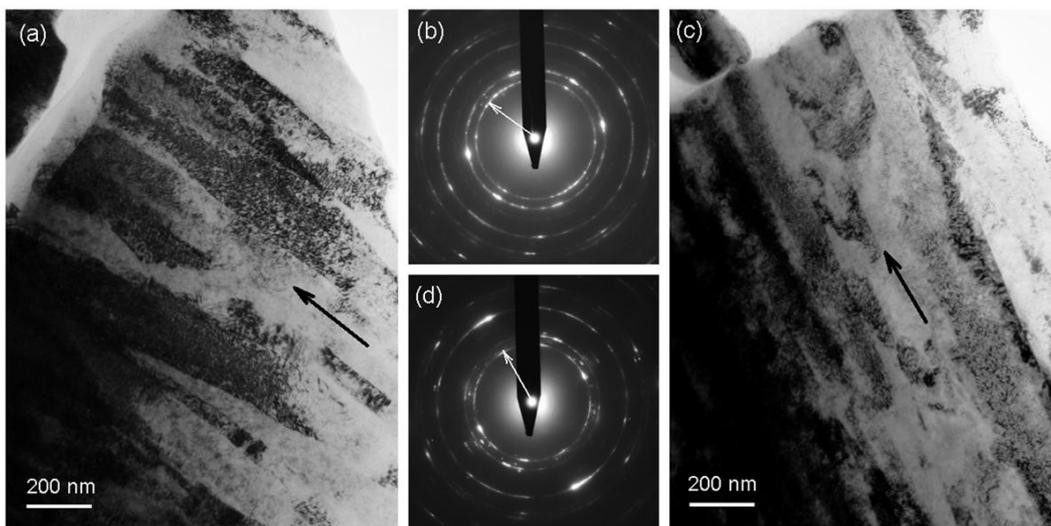


Fig. 4 Cross-sectional TEM images and selected area diffraction patterns of the TiN coatings: (a, c) grown by 4DC magnetrons; (b,d) grown by 3DC + 1HIPIMS.

the three DC magnetrons in the 3DC+1HIPIMS deposition can be deduced to be  $0.015 \mu\text{m}/\text{min}$  per magnetron, i.e. slightly lower than in the 4DC magnetron sputtering case. Nevertheless, the 3DC +1HIPIMS configuration achieved a reasonably high overall deposition rate of  $0.049 \mu\text{m}/\text{min}$ .

Figure 4 shows XTEM observations of the deposited TiN coatings. Figures 4a and 4d are bright field micrographs taken from the outer part of the coatings. Both coatings show void-free dense columnar structures. The rough growth front edges are consistent with the surface waviness (Figures 3a

and 3b). In Figures 4b and 4c, the selected area diffraction (SAD) patterns both show a NaCl-cubic crystalline structure of titanium nitride. Moreover, Figure 4b indicates a mixed texture (seeing the growth direction indicated by the arrow) with stronger (111) diffraction than the others in the coating grown under the 4DC mode. On the other hand, Figure 4c shows a (220) dominated texture. Figure 5 shows two XTEM images taken at the interface regions of the 4DC and 3DC+1HIPIMS TiN coatings respectively. Whilst the metallic Ti base layers exhibit dense columnar morphology, an

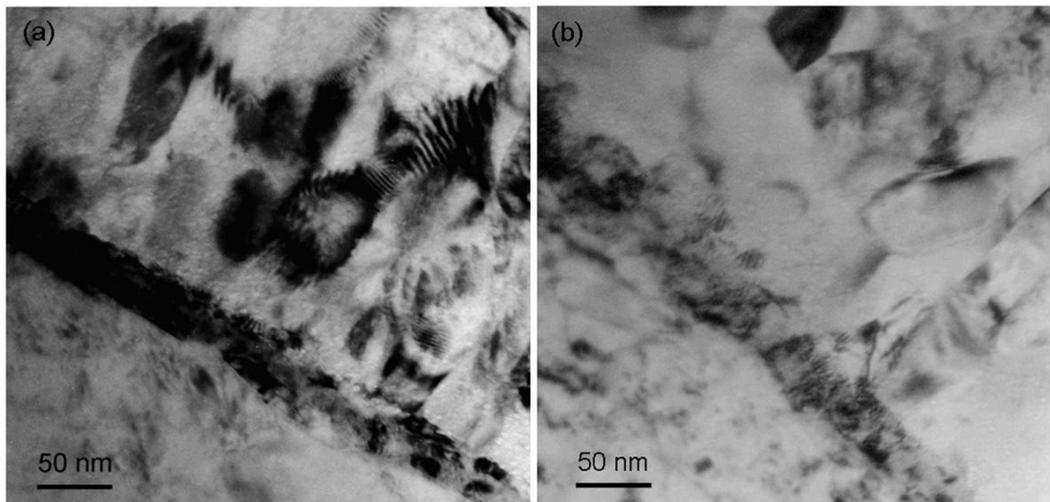


Fig. 5 Cross-sectional TEM images showing a nano scale interfacial film between the sputtered Ti base layer and the steel substrate: (a) grown by 4DC magnetrons; (b) grown by 3DC + 1HIPIMS.

interfacial film can be seen between the base layer and the substrate. The film in each case is approximately 30~50 nm thick, being incoherent with both the substrate and the base layer. It is likely that the interfacial film gave rise to the strong adhesion exhibited by these coatings. In previous research, it has been found that chromium ion etching in cathodic arc mode resulted in the formation of a metal implantation layer on the substrate steel when the substrate bias was lower than -600 V or an intermixed Cr-Fe layer when the bias was higher [18-19]. The interfacial films shown in Figure 5 may reflect implanted Ti, however additional experimental study is required to confirm that hypothesis.

Figure 6 shows XRD diagrams of the TiN coatings acquired at the Bragg-Brentano mode. Table 1 shows quantitative measurements of the diffraction peaks. Both coatings exhibit a cubic crystalline structure with strong (220) texture. Note that the 4DC magnetron sputtered TiN shows stronger (111) and (200) diffractions than the 3DC+1HIPIMS deposited coating, indicating a small contribution from randomly orientated grains (consistent to the SAD in Figure 4c). The hybrid deposited TiN shows slightly broader diffraction peaks, indicative of stronger lattice distortion. Table 1 also shows that, the hybrid deposited TiN shows a residual stress of -3.3 GPa, substantially lower than the DC sputtered coating. In [14], Luo et al reported that, in UBM sputtered TiAlN/VN multilayer coatings, the increase of substrate negative bias voltage from -75V to -95 V or higher voltages led to a texture transition from (220) to (111) and a substantial increase in the residual comprehensive stress. In the present study, the low residual stress measured in the hybrid deposited TiN

coating should be related to the (220) texture. It can be found that the lattice parameter measured by the Bragg-Brentano geometry is larger than the one measured by the  $\sin^2\psi$  method. This is because the latter is the stress-free value, whereas the former includes the influence of the residual comprehensive stress.

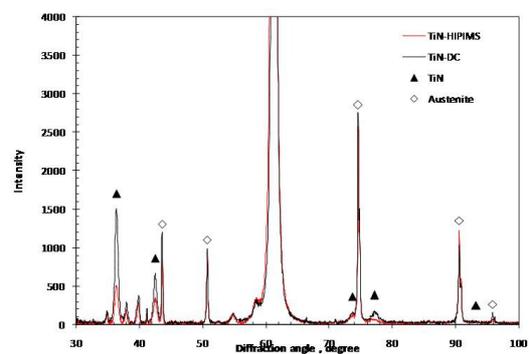


Fig. 6 XRD curves of the TiN coatings.

Table 1 Crystalline characteristics and residual stress measurements of the TiN coatings.

Properties	4DC	3DC+1HIPIMS
HK <sub>0.025</sub> , GPa	34.8 ± 3.8	38.0 ± 5.2
<i>Residual stress, GPa</i>		
On (111)	-6.0 ± 0.6	-3.3 ± 0.8
On (220)	-7.9 ± 1.0	-3.2 ± 1.2
<i>Lattice parameter a<sub>0</sub>, nm</i>		
Stress-free value	0.4231	0.4250
θ-2θ configuration	0.4262	0.4265
<i>Peak broadening (FWHM) degree</i>		
β <sub>(111)</sub>	0.561	0.594
β <sub>(200)</sub>	0.561	0.594
β <sub>(220)</sub>	0.858	0.957

### 2.3 Tribological properties

Figure 7 shows typical examples of the friction coefficients measured in the unlubricated sliding wear tests. Both coatings exhibited variation of friction coefficient in the running-in period by starting from a value less than 0.25 and increasing progressively to steady state above 0.9. The running-in process was associated with initial abrasive wear of the TiN coatings under the asperity contacts with the counterpart surfaces, leading to the generation of TiN wear particles and their subsequent breaking, adhesive attachment, and the formation of a tribofilm. The steady state friction was governed by the tribofilm. Relevant study about dry sliding tribofilms in similar nitrides can be found in publications<sup>[20-21]</sup>.

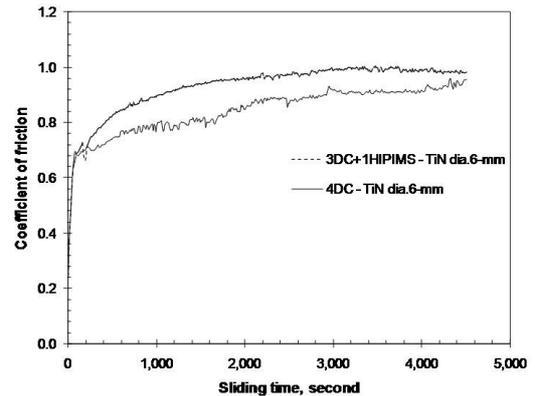


Fig. 7 Typical friction curves of the TiN coatings in unlubricated sliding against a WC-Co counterpart ball.

Table 2 Friction coefficient and wear properties of the TiN coatings.

Wear track dia. mm	Sliding time sec.	Coefficient of friction	Coefficient of wear $\times 10^{-15} \text{ m}^3 \text{ N}^{-1} \text{ m}^{-1}$	Wear track depth $\mu\text{m}$	Wear track width $\mu\text{m}$	Ball wear $\mu\text{m}$
<i>TiN by 4DC</i>						
6	4531	0.84	1.5	1.7	214	228
10	6454	0.97	1.2	1.3	192	221
<i>TiN by 3DC+1HIPIMS</i>						
6	4499	0.93	1.2	1.4	207	237
10	5404	0.96	2.0	1.6	240	263

The friction and wear properties of the coatings are summarised in Table 2. Four sets of tribotest experiments were carried out. The depths of the wear tracks created on the coatings ranged from 1.3 to 1.7  $\mu\text{m}$ , well within the coating thickness. The average coefficients of friction were 0.84 - 0.97, whereas the specific wear coefficients were of the order of  $10^{-15} \text{ m}^3 \text{ N}^{-1} \text{ m}^{-1}$ . The friction and wear properties of the TiN coatings measured in the current experiments are comparable to the results reported in literature under similar wear conditions<sup>[22-24]</sup>. It has been concluded from the current research that the TiN coating grown by the hybrid 3DC+1HIPIMS deposition has similar tribological properties when compared to the DC magnetron sputtered TiN coating.

### 3. Conclusions

(1) Using a hybrid 3DC+1HIPIMS deposition, a TiN coating has been grown reactively on steel substrates, to compare with a similar TiN grown by a simple 4DC magnetron sputtering. The hybrid process achieved a reasonably high deposition rate of 0.049  $\mu\text{m}/\text{min}$ , being about 23% lower than the rate achieved by the pure 4DC magnetron sputtering. Both coatings exhibited dense columnar structure,

smooth coating surfaces, and NaCl-type cubic crystalline structure with a strong (220) texture.

(2) The HIPIMS incorporation in the magnetron deposition led to an increase of hardness from  $\text{HK}_{0.025}$  34.8 to 38.0 GPa, and simultaneously a decrease in the magnitude of the residual compressive stress from -6.0 to -3.3 GPa.

(3) The TiN coatings showed friction coefficients in a range of 0.8 - 0.9 and a wear coefficient of the order of  $10^{-15} \text{ m}^3 \text{ N}^{-1} \text{ m}^{-1}$ , for both deposition techniques.

(4) Both the techniques produced coatings with excellent adhesion, being attributed to the applied pulsed DC ion etching and the deposition of a metallic Ti base layer combined with the gradual introduction of the reactive nitrogen gas.

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